

SPECIFICATION

Part No. : **DBP.433.T.A.30**

Description : Dielectric Band Pass Filter for 433MHz

Bandwidth 2MHz

Features : Center Frequency 433.92MHz

Supports ISM 433.05MHz to 434.79MHz use.

Low Insertion Loss

Low Pass-Band Ripple

High Ultimate Attenuation

Dims: 10*7.5*3.7mm







1. Introduction

Taoglas are utilizing their deep understanding of the RF component design and manufacturing process to provide high-quality, small-form-factor, cost-effective and easy to implement RF filters. The Taoglas Filters Division will feature a range of off-the-shelf filters for a variety of applications, including filters for emerging license free bands used for IoT and for GPS L1/L2 and L1/L5 applications. We can also work with customers to develop bespoke filter solutions.

Taoglas dielectric filters are designed to be used in wireless transmitters or receivers. These filters are designed to protect the LNA from noisy out of band emissions originated from nearby transmitters that can overdrive, or even damage your LNA. Overdriving the LNA results in non-linear distortion which negatively impacts the sensitivity of your receiver.

By selecting the proper Taoglas filter you can eliminate unnecessary out of band noise while maintaining minimal in-band insertion loss. The filter is manufactured as a single ceramic block [monoblock] which provides high reliability, low insertion loss and high attenuation in a simple compact SMD package.

The DBP.433.T.A.30 is a standard Taoglas product but can be customized for specific customer needs. For more information please contact your regional sales office.



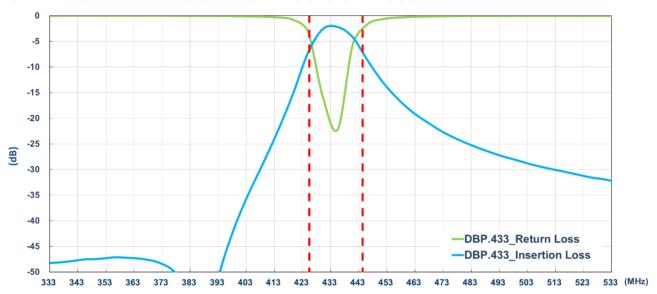
2. Specification

ELECTRICAL			
Centre Frequency (Fo)	433.92MHz		
3dB Bandwidth	10MHz		
Insertion Loss	3.0 dB max		
Passband Ripple	0.5 dB max		
Return Loss	< -10 dB		
	> 45.0 dB @ 0 ~ 390 MHz		
Attenuation	> 17.0 dB @ 390 MHz ~ 410 MHz		
	> 14.0 dB @ 468 MHz ~ 480 MHz		
	> 20.0 dB @ 480 MHz ~1 GHz		
In/Out Impedance	50 Ω		
Power Dissipation	1.0 W min.		
MECHANICAL			
Dimension	Dimension 10 x 7.5 x 3.7 (L x W x H)		
Material	Ceramic		
Finish	Ag plated		
ENVIRONMENTAL			
Operating Temperature	-40°C to 85°C		
Storage Temperature	-40°C to 85°C		

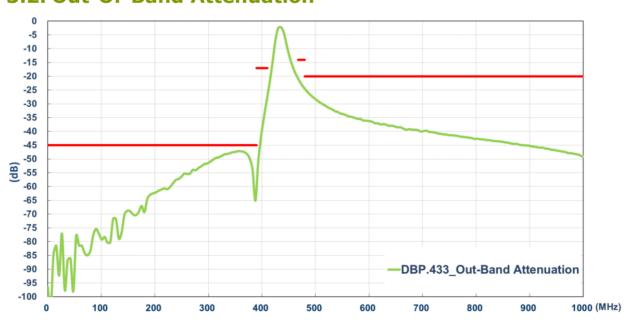


3. Characteristics Curve

3.1. Pass Band Return & Insertion Loss



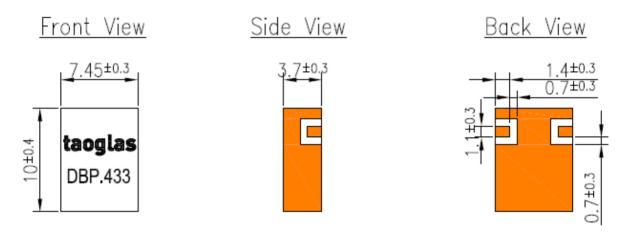
3.2. Out-Of-Band Attenuation





4. Mechanical Drawings (Unit: mm)

4.1. Antenna Drawing



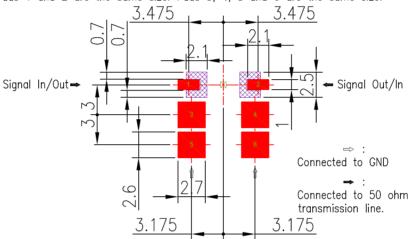


4.2. Recommended PCB Layout 4.2.1. Top Copper

Pads 1 and 2 should be connected to a 50 ohm transmission line.

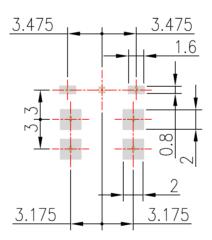
Pads 3, 4, 5 and 6 are connected to GND.

Pads 1 and 2 are the same size. Pads 3, 4, 5 and 6 are the same size.



4.2.2. Top Solder Paste

Pads 1 and 2 are the same size. Pads 3, 4, 5 and 6 are the same size.



NOTE:

- 1. Ag Plated area
- 2. Solder Mask area
- 3. Copper area
- 4. Paste area
- 5. Copper Keepout Area

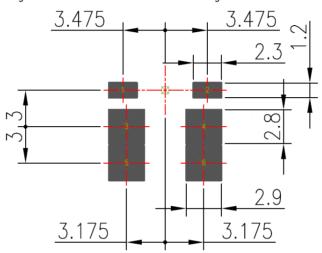


- 6. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.
- 7. The dimension tolerances should follow standard PCB manufacturing quidelines

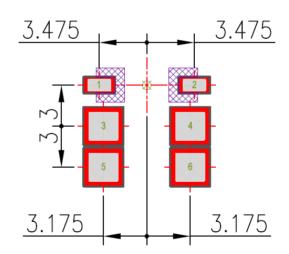


4.2.3. Top Solder Mask

Pads 1 and 2 are the same size. Pads 3, 4, 5 and 6 are the same size. This drawing is a negative of solder mask. Black regions are anti—mask.



4.2.4. Composite Diagram



NOTE:

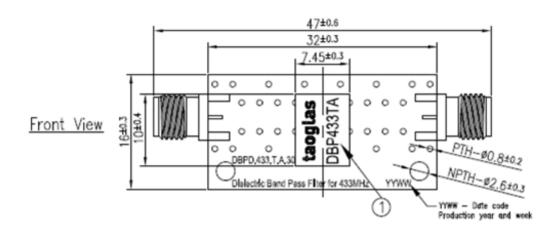
- 1. Ag Plated area
- 2. Solder Mask area
- 3. Copper area
- 4. Paste area
- 5. Copper Keepout Area

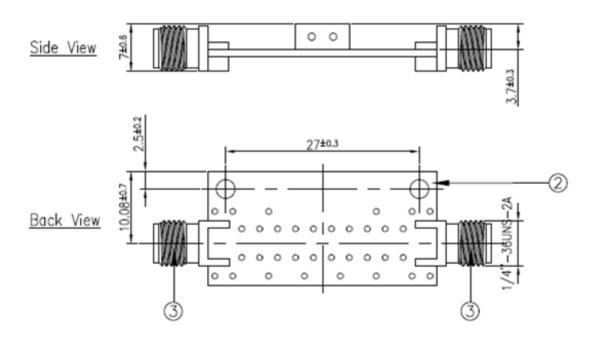


- 6. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.
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4.3. Evaluation Board





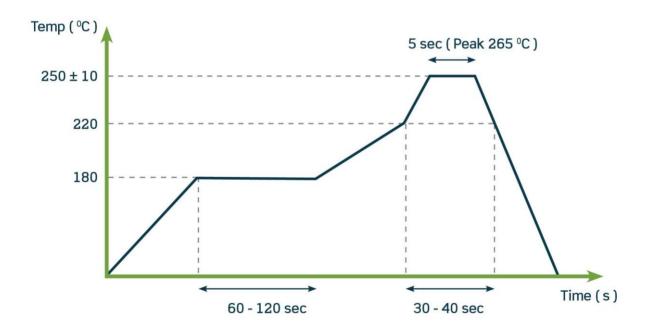
NOTE: 1.All material must be RoHS compliant.

	Name	Material	Finish	QTY
1	Filter	Ceramic	Clear	1
2	PCB	Composite 1.0t	Black	1
3	SMA(F) ST	Brass	Au Plated	2



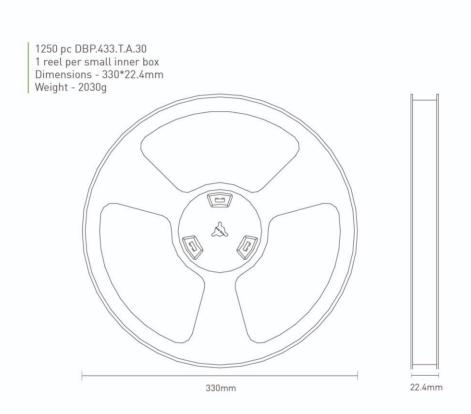
5. Recommended Reflow Soldering Profile

Phase	Profile Features	Maximum
Preheat	Temperature Min	150 °C
	Temperature Max	180 °C
	Duration	60-120 sec
Ramp-Up	Avg. Ramp up rate	3 °C/sec (max)
Reflow	Temperature	220 °C
Reliew	Duration	30-40 sec
Peak	Temperature	265 °C
, san	Duration	5 sec Max
Ramp Down	Avg. Ramp down rate	3 °C/sec (max)



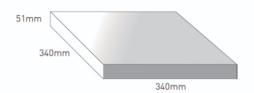


6. Recommended Reflow Soldering Profile

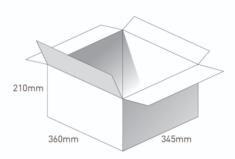




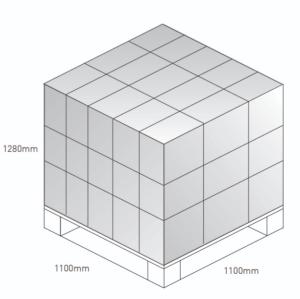
2500 pc DBP.433.T.A.30 2 reel in small inner box Dimensions - 340*340*51 Weight - 4.17Kg



4 inner boxes / 10000 pcs in one carton Carton Dimensions - 210*345*360mm Weight -17.2Kg



Pallet Dimensions 1100*1100*1280mm 24 Cartons per Pallet 6 Cartons per layer 4 Layers





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